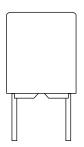




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Metallized Polyester Film Capacitors MKT Radial Potted Types



FEATURES

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ROHS COMPLIANT HALOGEN FREE

GREEN

(5-2008)

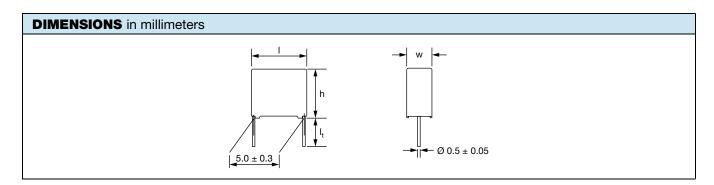
APPLICATIONS

Blocking, bypassing, filtering and timing, high frequency coupling and decoupling for fast digital and analog ICs, interference suppression in low voltage applications.

QUICK REFERENCE DATA Capacitance range 1 nF to 1.0 µF (E12 series) \pm 20 % (M), \pm 10 % (K), \pm 5 % (J) Capacitance tolerance 55/100/56 for rated voltage 63 V Climatic testing class according to IEC 60068-1 55/105/56 for rated voltage > 63 V Reference specifications IEC 60384-2 Dielectric Polyester film Electrodes Metallized Mono construction Construction Encapsulation Flame retardant plastic case and epoxy resin sealed (UL-class 94 V-0) Tinned wire Leads Manufacturer's logo/type/C-value/rated voltage/tolerance/date of manufacture Marking Rated DC voltage $63 \; V_{DC}, \, 100 \; V_{DC}, \, 250 \; V_{DC}, \, 400 \; V_{DC}$ 40 V_{AC}, 63 V_{AC}, 160 V_{AC}, 200 V_{AC} Rated AC voltage 85 °C Rated temperature 100 °C for rated voltage 63 V Maximum application temperature 105 °C for rated voltage > 63 V 1 (long life) Performance grade

Note

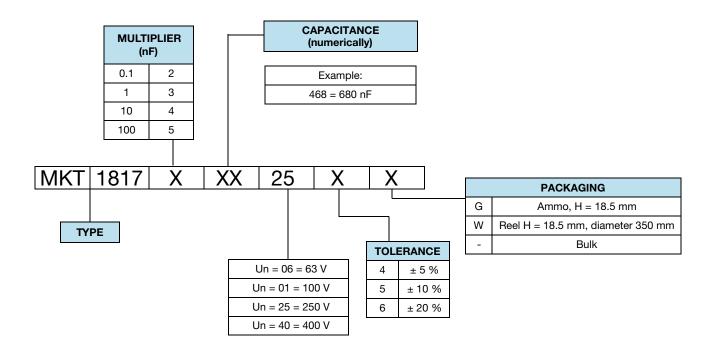
For more detailed data and test requirements, contact <u>dc-film@vishay.com</u>





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COMPOSITION OF CATALOG NUMBER



SPECIFIC REFERENCE DATA					
DESCRIPTION		VALUE			
Tangent of loss angle:		at 1 kHz	at 10 kHz	at 100 kHz	
$C \le 0.1 \ \mu F$		≤ 80 x 10 ⁻⁴	≤ 150 x 10 ⁻⁴	≤ 250 x 10 ⁻⁴	
$0.1~\mu F < C \leq 1.0~\mu F$		\leq 80 x 10 ⁻⁴	≤ 150 x 10 ⁻⁴	-	
PITCH		RATED VOLTAGE PULSE SLOPE (dU/dt) _R AT			
(mm)	63 V _{DC}	100 V _{DC}	250 V _{DC}	400 V _{DC}	
5	60	110	330	630	
If the maximum pulse volta	age is less than the rated vol	tage higher dV/dt values car	n be permitted.		
R between leads, for $C \le 0$	0.33 µF and U _R ≤ 100 V	> 15 000 MΩ			
R between leads, for C \leq 0.33 μ F and U _R $>$ 100 V		$>$ 30 000 M Ω			
RC between leads, for C > 0.33 μF and $U_R \le 100 \text{ V}$		> 5000 s			
RC between leads, for C > 0.33 μ F and U _R > 100 V		> 10 000 s			
R between interconnecting leads and casing 100 V (foil method)		> 30 000 MΩ			
Withstanding (DC) voltage (cut off current 10 mA) $^{(1)}$; rise time \leq 1000 V/s		1.6 x U _{RDC} , 1 min			
Withstanding (DC) voltage between leads and case		2.0 x U _{RDC} , with minimum of 200 V _{DC} ; 1 min			
Maximum application temperature		100 °C for rated voltage 63 V 105 °C for rated voltage > 63 V			

Note

⁽¹⁾ See "Voltage Proof Test for Metalized Film Capacitors": www.vishay.com/doc?28169



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ELECTRICAL DATA					
U _{RDC} (V)	CAP. (µF)	CAPACITANCE CODE	VOLTAGE CODE	V _{AC}	DIMENSIONS w x h x l (mm)
	0.10	-410			2.5 x 6.5 x 7.2
	0.15	-415			2.5 x 6.5 x 7.2
	0.22	-422			3.5 x 8.0 x 7.2
63	0.33	-433	06	40	3.5 x 8.0 x 7.2
	0.47	-447			3.5 x 8.0 x 7.2
	0.68	-468			4.5 x 9.0 x 7.2
	1.0	-510			6.0 x 11.0 x 7.2
	0.022	-322			2.5 x 6.5 x 7.2
	0.033	-333			2.5 x 6.5 x 7.2
	0.047	-347			2.5 x 6.5 x 7.2
100	0.068	-368	01	63	2.5 x 6.5 x 7.2
100	0.10	-410		03	2.5 x 6.5 x 7.2
	0.15	-415			3.5 x 8.0 x 7.2
	0.22	-422			4.5 x 9.0 x 7.2
	0.33	-433			4.5 x 9.0 x 7.2
	0.0033	-233			2.5 x 6.5 x 7.2
	0.0047	-247			2.5 x 6.5 x 7.2
	0.0068	-268	25		2.5 x 6.5 x 7.2
	0.010	-310		160	2.5 x 6.5 x 7.2
250	0.015	-315			2.5 x 6.5 x 7.2
230	0.022	-322			3.5 x 8.0 x 7.2
	0.033	-333			3.5 x 8.0 x 7.2
	0.047	-347			4.5 x 9.0 x 7.2
	0.068	-368			6.0 x 11.0 x 7.2
	0.10	-410			6.0 x 11.0 x 7.2
	0.0033	-233		160	2.5 x 6.5 x 7.2
	0.0047	-247			2.5 x 6.5 x 7.2
	0.0068	-268	25		2.5 x 6.5 x 7.2
	0.010	-310			2.5 x 6.5 x 7.2
250	0.015	-315			2.5 x 6.5 x 7.2
230	0.022	-322	25		3.5 x 8.0 x 7.2
	0.033	-333			3.5 x 8.0 x 7.2
	0.047	-347			4.5 x 9.0 x 7.2
	0.068	-368			6.0 x 11.0 x 7.2
	0.10	-410	<u> </u>		6.0 x 11.0 x 7.2
	0.0010	-210		_	2.5 x 6.5 x 7.2
	0.0015	-215]	200	2.5 x 6.5 x 7.2
	0.0022	-222	40		2.5 x 6.5 x 7.2
	0.0033	-233			2.5 x 6.5 x 7.2
400	0.0047	-247			2.5 x 6.5 x 7.2
	0.0068	-268			2.5 x 6.5 x 7.2
	0.010	-310			3.5 x 8.0 x 7.2
	0.015	-315			3.5 x 8.0 x 7.2
	0.022	-322			4.5 x 9.0 x 7.2

RECOMMENDED PACKAGING					
PACKAGING CODE	TYPE OF PACKAGING	HEIGHT (H) (mm)	REEL DIAMETER (mm)	ORDERING CODE EXAMPLES	PITCH 5
G	Ammo	18.5	S ⁽¹⁾	MKT1817233255G	Х
W	Reel	18.5	350	MKT1817233255W	Х
-	Bulk	-	-	MKT1817233255	Х

Note

(1) S = box size 55 mm x 210 mm x 340 mm (w x h x l)



MKT1817

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Normal Use

The capacitors are designed for mounting on printed-circuit boards. The capacitors packed in bandoliers are designed for mounting in printed-circuit boards by means of automatic insertion machines.

For detailed tape specifications refer to packaging information www.vishay.com/docs?28139

Specific Method of Mounting to Withstand Vibration and Shock

In order to withstand vibration and shock tests, it must be ensured that the stand-off pips are in good contact with the printed-circuit board.

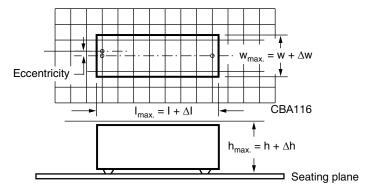
- For pitches ≤ 15 mm the capacitors shall be mechanically fixed by the leads
- For larger pitches the capacitors shall be mounted in the same way and the body clamped

Space Requirements on Printed-Circuit Board

The maximum space for length (I_{max.}), width (w_{max.}) and height (h_{max.}) of film capacitors to take in account on the printed-circuit board is shown in the drawings.

• For products with pitch \leq 15 mm, $\Delta w = \Delta l = 0.3$ mm; $\Delta h = 0.1$ mm

Eccentricity defined as in drawing. The maximum eccentricity is smaller than or equal to the lead diameter of the product concerned.



SOLDERING CONDITIONS

For general soldering conditions and wave soldering profile, we refer to the document "Characteristics and Definitions Used for Film Capacitors": www.vishay.com/doc?28147

Storage Temperature

T_{stq} = -25 °C to +35 °C with RH maximum 75 % without condensation

Ratings and Characteristics Reference Conditions

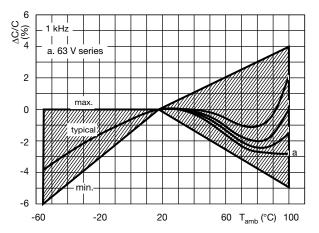
Unless otherwise specified, all electrical values apply to an ambient free air temperature of 23 °C ± 1 °C, an atmospheric pressure of 86 kPa to 106 kPa and a relative humidity of 50 % \pm 2 %.

For reference testing, a conditioning period shall be applied over 96 h ± 4 h by heating the products in a circulating air oven at the rated temperature and a relative humidity not exceeding 20 %.

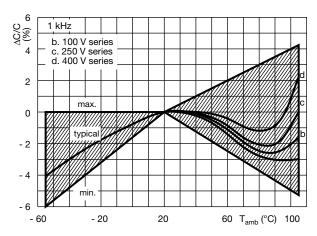


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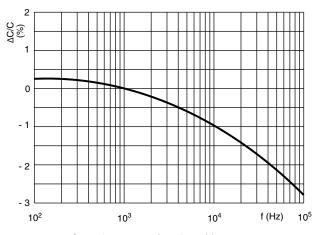
CHARACTERISTICS



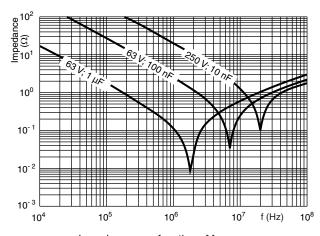
Capacitance as a function of ambient temperature (typical) for voltage 63 V



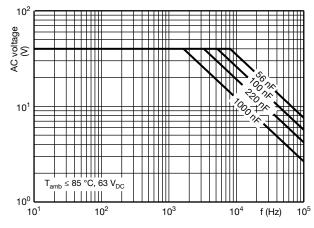
Capacitance as a function of ambient temperature (typical) for voltages > 63 V



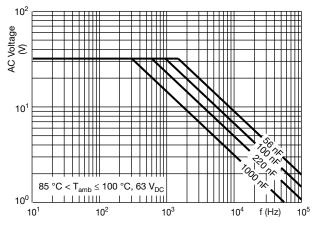
Capacitance as a function of frequency (typical curve)



Impedance as a function of frequency



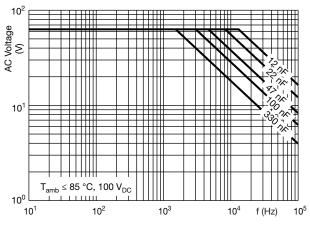
Max. AC voltage as a function of frequency



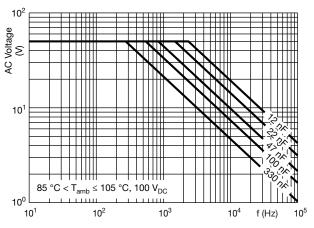
Max. AC voltage as a function of frequency



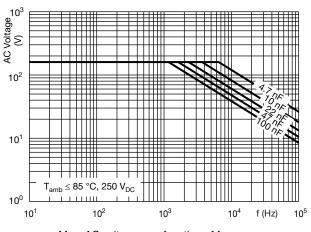
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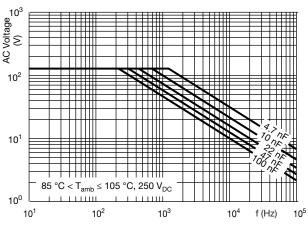
Max. AC voltage as a function of frequency



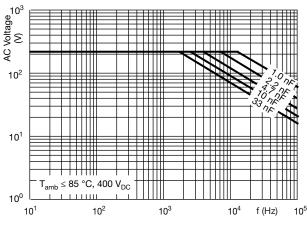
Max. AC voltage as a function of frequency

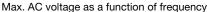


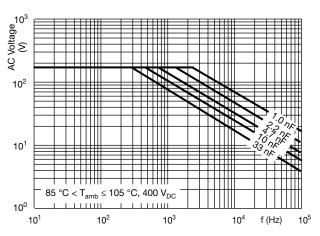
Max. AC voltage as a function of frequency



Max. AC voltage as a function of frequency







Max. AC voltage as a function of frequency

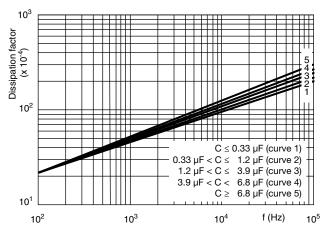


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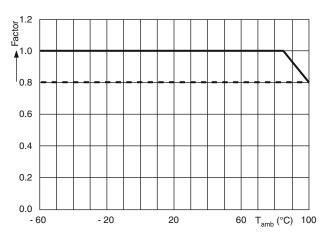
Maximum RMS Current (Sinewave) as a Function of Frequency

The maximum RMS current is defined by $I_{ac} = \omega \times C \times U_{ac}$.

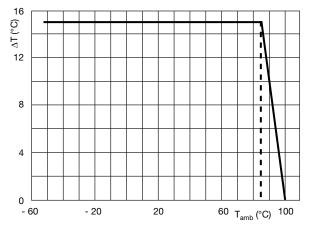
 U_{AC} is the maximum AC voltage depending on the ambient temperature in the curves "Max. RMS voltage and AC current as a function of frequency".



Tangent of loss angle as a function of frequency (typical curve)

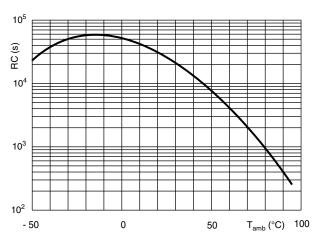


Max. DC and AC voltage as a function of temperature for voltage 63 V

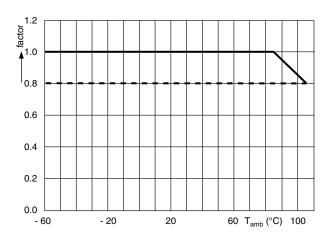


Maximum allowed component temperature rise (ΔT) as a function of the ambient temperature T_{amb} for voltage 63 V

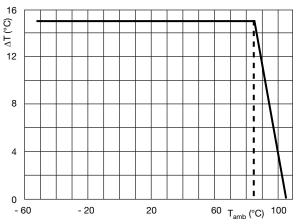
Revision: 19-Aug-15



Insulation resistance as a function of the ambient temperature (typical curve)



Max. DC and AC voltage as a function of temperature for voltages > 63 V



Maximum allowed component temperature rise (ΔT) as a function of the ambient temperature T_{amb} for voltages > 63 V





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HEAT CONDUCTIVITY (G) AS A FUNCTION OF (ORIGINAL) PITCH AND CAPACITOR BODY THICKNESS IN mW/°C			
W _{max.} HEAT CONDUCTIVITY (mW/°C)			
(mm)	PITCH 5 mm		
2.5	2.5		
3.0	3.0		
4.5	4.0		
6.0	5.5		

POWER DISSIPATION AND MAXIMUM COMPONENT TEMPERATURE RISE

The power dissipation must be limited in order not to exceed the maximum allowed component temperature rise as a function of the free ambient temperature.

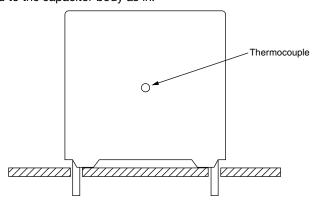
The power dissipation can be calculated according type detail specification "HQN-384-01/101: Technical Information Film Capacitors".

The component temperature rise (ΔT) can be measured (see section "Measuring the Component Temperature" for more details) or calculated by $\Delta T = P/G$:

- ΔT = component temperature rise (°C)
- P = power dissipation of the component (mW)
- G = heat conductivity of the component (mW/°C)

MEASURING THE COMPONENT TEMPERATURE

A thermocouple must be attached to the capacitor body as in:



The temperature is measured in unloaded (T_{amb}) and maximum loaded condition (T_{C}). The temperature rise is given by $\Delta T = T_{C} - T_{amb}$.

To avoid radiation or convection, the capacitor should be tested in a wind-free box.

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APPLICATION NOTE AND LIMITING CONDITIONS

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These capacitors are not suitable for mains applications as across-the-line capacitors without additional protection, as described hereunder. These mains applications are strictly regulated in safety standards and therefore electromagnetic interference suppression capacitors conforming the standards must be used.

For capacitors connected in parallel, normally the proof voltage and possibly the rated voltage must be reduced. For information depending of the capacitance value and the number of parallel connections contact: dc-film@vishav.com

To select the capacitor for a certain application, the following conditions must be checked:

- 1. The peak voltage (U_P) shall not be greater than the rated DC voltage (U_{RDC})
- The peak-to-peak voltage (U_{P-P}) shall not be greater than 2√2 x U_{RAC} to avoid the ionization inception level
- The voltage peak slope (dU/dt) shall not exceed the rated voltage pulse slope in an RC-circuit at rated voltage and without ringing. If the pulse voltage is lower than the rated DC voltage, the rated voltage pulse slope may be multiplied by U_{RDC} and divided by the applied voltage.

For all other pulses following equation must be fulfilled:

$$2 \times \int_{0}^{T} \left(\frac{dU}{dt}\right)^{2} \times dt < U_{RDC} \times \left(\frac{dU}{dt}\right)_{rated}$$

T is the pulse duration.

- 4. The maximum component surface temperature rise must be lower than the limits (see graph "Max. allowed component temperature rise").
- 5. Since in circuits used at voltages over 280 V peak-to-peak the risk for an intrinsically active flammability after a capacitor breakdown (short circuit) increases, it is recommended that the power to the component is limited to 100 times the values mentioned in the table: "Heat Conductivity"
- 6. When using these capacitors as across-the-line capacitor in the input filter for mains applications or as series connected with an impedance to the mains the applicant must guarantee that the following conditions are fulfilled in any case (spikes and surge voltages from the mains included).

VOLTAGE CONDITIONS FOR 6 ABOVE				
ALLOWED VOLTAGES Tamb ≤ 85 °C < T _{amb} ≤ 100 °C FOR 63 \				
ALLOWED VOLTAGES	T _{amb} ≤ 85 °C	85 °C < T _{amb} ≤ 100 °C FOR > 63 V		
Maximum continuous RMS voltage	U _{RAC}	See "Max. AC voltage as function of temperature" per characteristics		
Maximum temperature RMS-overvoltage (< 24 h)	1.25 x U _{RAC}	U _{RAC}		
Maximum peak voltage (V _{O-P}) (< 2 s)	1.6 x U _{RDC}	1.3 x U _{RDC}		

Example

C = 330 nF - 63 V used for the voltage signal shown in next drawing.

 $U_{P-P} = 40 \text{ V}$; $U_P = 35 \text{ V}$; $T_1 = 100 \text{ }\mu\text{s}$; $T_2 = 200 \text{ }\mu\text{s}$

The ambient temperature is 35 °C

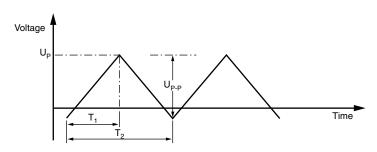
Checking conditions:

- 1. The peak voltage U_P = 35 V is lower than 63 V_{DC}
- 2. The peak-to-peak voltage 40 V is lower than $2\sqrt{2}$ x 40 V_{AC} = 113 U_{P-P}
- 3. The voltage pulse slope $(dU/dt) = 40 \text{ V}/100 \text{ }\mu\text{s} = 0.4 \text{ V}/\mu\text{s}$

This is lower than 60 V/µs (see specific reference data for each version)

- 4. The dissipated power is 16.2 mW as calculated with fourier terms The temperature rise for w_{max.} = 3.5 mm and pitch = 5 mm will be 16.2 mW/3.0 mW/°C = 5.4 °C This is lower than 15 °C temperature rise at 35 °C, according figure "Max. allowed component temperature rise"
- 5. Not applicable
- 6. Not applicable

Voltage Signal





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INSPECTION REQUIREMENTS

General Notes

Sub-clause numbers of tests and performance requirements refer to the "Sectional Specification, Publication IEC 60384-2 and Specific Reference Data".

GROUP C INSPECTION REQUIREMENTS			
SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS	
SUB-GROUP C1A PART OF SAMPLE OF SUB-GROUP C1			
4.1 Dimensions (detail)		As specified in chapters "MKT370 General Data" of this specification	
4.3.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 470 nF at 100 kHz for C > 470 nF at 10 kHz		
4.3 Robustness of terminations	Tensile and bending	No visible damage	
4.4 Resistance to soldering heat	Method: 1A Solder bath: 280 °C ± 5 °C Duration: 10 s		
4.14 Component solvent resistance	Isopropylalcohol at room temperature Method: 2 Immersion time: 5 min ± 0.5 min Recovery time: min. 1 h, max. 2 h		
4.4.2 Final measurements	Visual examination	No visible damage Legible marking	
	Capacitance	$ \Delta C/C \le 2$ % of the value measured initially	
	Tangent of loss angle	Increase of tan δ : ≤ 0.005 for: C ≤ 100 nF or ≤ 0.010 for: 100 nF < C ≤ 220 nF or ≤ 0.015 for: 220 nF < C ≤ 470 nF or ≤ 0.003 for: C > 470 nF Compared to values measured in 4.3.1	
SUB-GROUP C1B OTHER PART OF SAMPLE OF SUB-GROUP C1			
4.6.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 470 nF at 100 kHz for C > 470 nF at 10 kHz		
4.6 Rapid change of temperature	$\theta A = -55 ^{\circ}C$ $\theta B = +100 ^{\circ}C$ 5 cycles Duration t = 30 min		
4.7 Vibration	Visual examination Mounting: see section "Mounting" of this specification Procedure B4 Frequency range: 10 Hz to 55 Hz Amplitude: 0.75 mm or Acceleration 98 m/s² (whichever is less severe) Total duration 6 h	No visible damage	



GROUP C INSPECTION REQUIREMENTS SUB-CLAUSE NUMBER AND TEST CONDITIONS PERFORMANCE REQUIREMENT CONDITIONS PERFORMANCE REQUIREMENT			DEDECOMANCE DECUMPRACTICS
SUB-CLAUSE NUMBER AND TEST SUB-GROUP C1B OTHER PART OF SAMPLE OF SUB-GROUP C1		CONDITIONS	PERFORMANCE REQUIREMENTS
4.7.2	Final inspection	Visual examination	No visible damage
4.9	Shock	Mounting: see section "Mounting" of this specification Pulse shape: half sine Acceleration: 490 m/s² Duration of pulse: 11 ms	
4.9.3	Final measurements	Visual examination	No visible damage
		Capacitance	$ \Delta C/C \le 3$ % of the value measured in 4.6.1
		Tangent of loss angle	Increase of tan δ : ≤ 0.010 for: C ≤ 220 nF or ≤ 0.015 for: 220 nF $<$ C ≤ 470 nF or ≤ 0.003 for: C > 470 nF Compared to values measured in 4.6.1
		Insulation resistance	As specified in section "Specific Reference Data 370" of this specification
OF SPI	ROUP C1 COMBINED SAMPLE ECIMENS OF SUB-GROUPS ND C1B		
4.10	Climatic sequence		
4.10.2	Dry heat	Temperature: +100 °C for rated voltage 63 V +105 °C for rated voltage > 63 V Duration: 16 h	
4.10.3	Damp heat cyclic Test Db, first cycle		
4.10.4	Cold	Temperature: -55 °C Duration: 2 h	
4.10.6	Damp heat cyclic Test Db, remaining cycles	Voltage proof = U _{RDC} for 1 min within 15 min after removal from testchamber	No breakdown or flash-over
4.10.6.2	2 Final measurements	Visual examination	No visible damage Legible marking
		Capacitance	$ \Delta C/C \le 3$ % of the value measured in 4.4.2 or 4.9.3
		Tangent of loss angle	Increase of $\tan \delta$: ≤ 0.010 for: $C \leq 220$ nF or ≤ 0.015 for: 220 nF $< C \leq 470$ nF or ≤ 0.005 for: $C > 470$ nF Compared to values measured in 4.3.1 or 4.6.1
		Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this specification



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GROUP C INSPECTION REQUIREMENTS SUB-CLAUSE NUMBER AND TEST CONDITIONS PERFORMANCE REQUIREMENT				
SUB-GROUP C2	CONDITIONS	TENI ONIMANOE NEGONIEMENTO		
4.11 Damp heat steady state	56 days, 40 °C, 90 % to 95 % RH			
4.11 Damp near steady state	00 days, 40 °C, 00 70 to 00 70 111			
4.11.1 Initial measurements	Capacitance			
	Tangent of loss angle at 1 kHz			
4.11.3 Final measurements	Voltage proof = U _{RDC} for 1 min within 15 min	No breakdown or flash-over		
	after removal from testchamber			
	Visual examination	No visible damage		
	Visual Statissianist	Legible marking		
	Capacitance	$ \Delta C/C \le 5$ % of the value measured in 4.11.1		
	Tangent of loss angle	Increase of tan δ : \leq 0.005		
		Compared to values measured in 4.11.1		
	Insulation resistance	≥ 50 % of values specified in section		
	insulation resistance	"Specific Reference Data 370" of this		
		specification		
SUB GROUP C3				
4.12 Endurance	Duration: 2000 h 1.25 x U _{RDC} at 85 °C			
	0.8 x 1.25 U _{RDC} at 100 °C			
	for rated voltage 63 V			
	0.8 x 1.25 U _{RDC} at 105 °C			
	for rated voltage > 63 V			
4.12.1 Initial measurements	Capacitance			
	Tangent of loss angle:			
	for C ≤ 470 nF at 100 kHz for C > 470 nF at 10 kHz			
	101 0 7 470 111 at 10 KHZ			
4.12.5 Final measurements	Visual examination	No visible damage		
		Legible marking		
	Capacitance	$ \Delta C/C \le 5$ % compared to values measured		
		in 4.12.1		
	Tangent of loss angle	Increase of tan δ :		
	rangent of loop angle	≤ 0.005 at 85 °C		
		≤ 0.010 at 100 °C for: C ≤ 220 nF or		
		\leq 0.015 for: 220 nF < C \leq 470 nF or \leq 0.003 for: C > 470 nF		
		Compared to values measured in 4.12.1		
	Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this		
		specific helefelice Data 370 of this		



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GROUP C INSPECTION REQUIREMENTS			
SUB-CLAUSE NUMBER AND TEST	CONDITIONS	PERFORMANCE REQUIREMENTS	
SUB-GROUP C4			
4.13 Charge and discharge	10 000 cycles Charged to U _{RDC}		
	Discharge resistance: $R = \frac{U_R}{C \times 2.5 \times (dU/dt)_R}$		
4.13.1 Initial measurements	Capacitance Tangent of loss angle: for C ≤ 470 nF at 100 kHz for C > 470 nF at 10 kHz		
4.13.3 Final measurements	Capacitance	$\left \Delta C/C \right \leq 3$ % compared to values measured in 4.13.1	
	Tangent of loss angle	Increase of $\tan \delta$: ≤ 0.005 for: C ≤ 100 nF or ≤ 0.010 for: 100 nF $<$ C ≤ 220 nF or ≤ 0.015 for: 220 nF $<$ C ≤ 470 nF or ≤ 0.003 for: C > 470 nF Compared to values measured in 4.13.1	
	Insulation resistance	≥ 50 % of values specified in section "Specific Reference Data 370" of this specification	



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Vishay

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